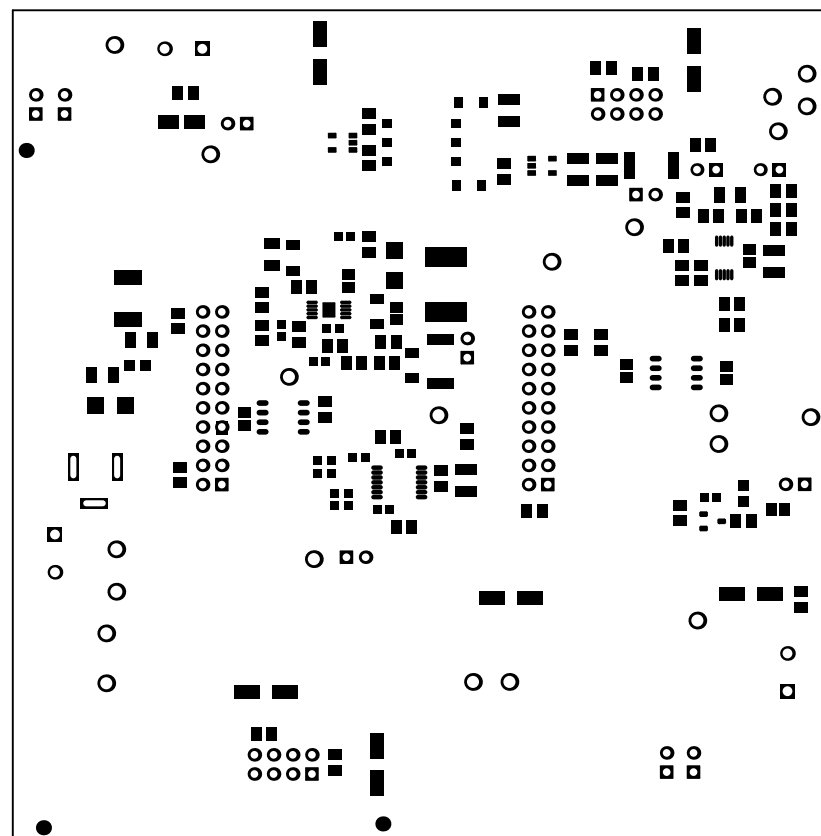
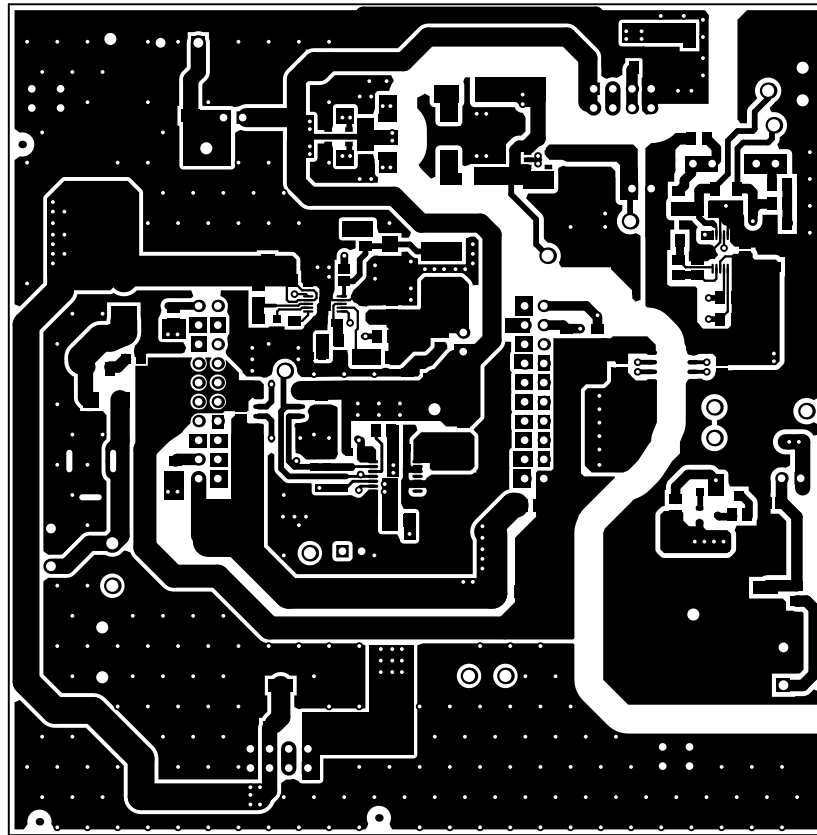


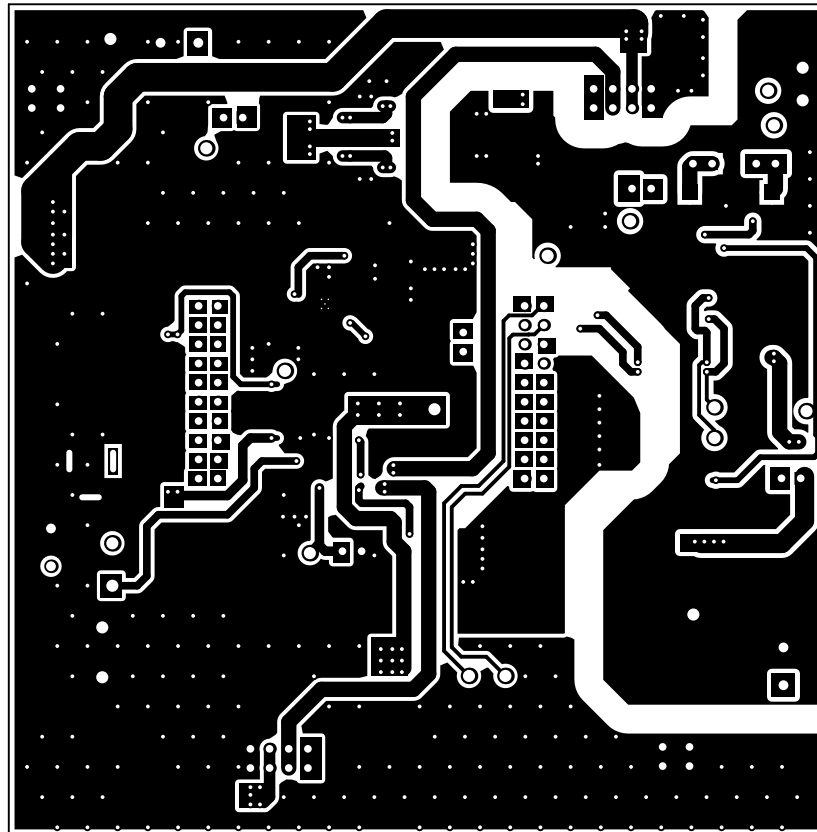
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00794	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00794		
PLOT NAME = Top Overlay	GENERATED : 3/23/2016 4:58:58 PM	TEXAS INSTRUMENTS	



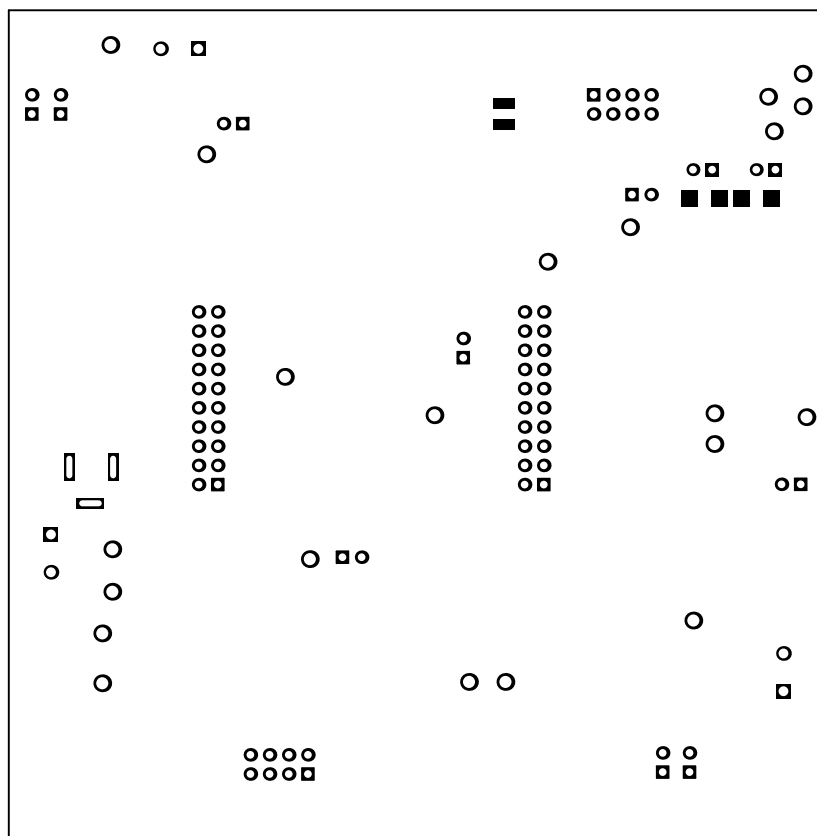
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00794	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00794		
PLOT NAME = Top Solder Mask	GENERATED : 3/23/2016 4:59:02 PM	TEXAS INSTRUMENTS	



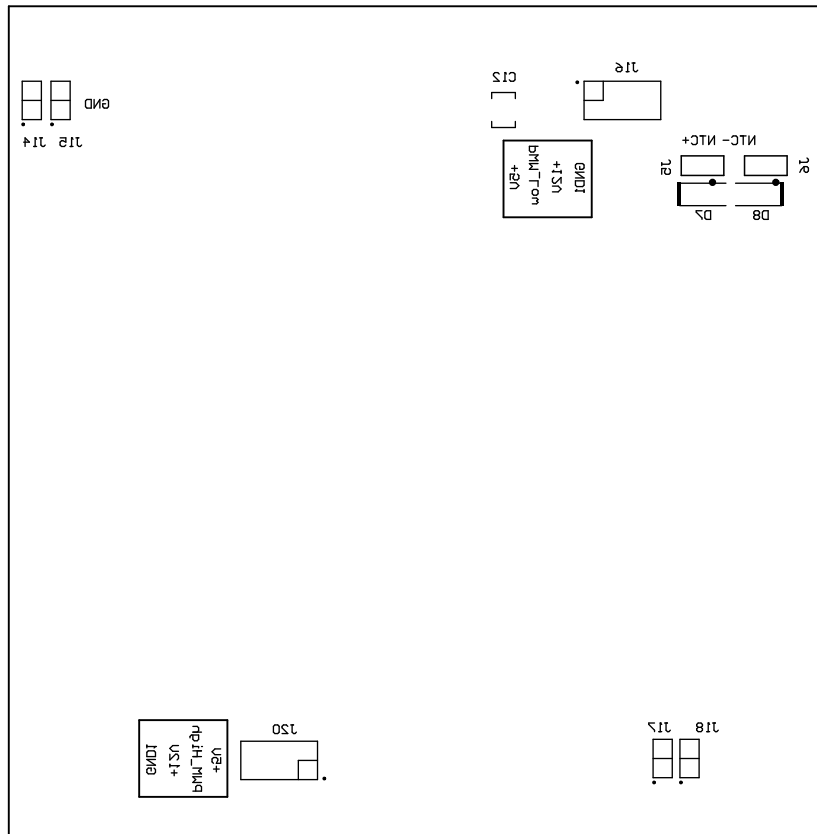
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00794	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-00794		
PLOT NAME = Top Layer	GENERATED : 3/23/2016 4:59:06 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00794	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-00794		
PLOT NAME = Bottom Layer	GENERATED : 3/23/2016 4:59:11 PM	TEXAS INSTRUMENTS	



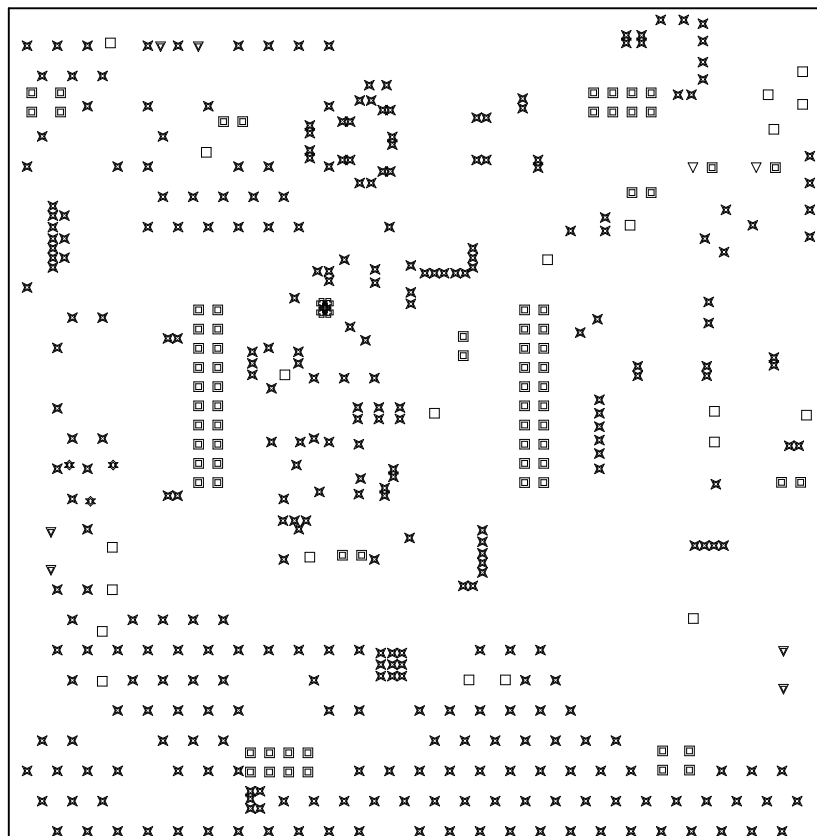
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00794	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00794		
PLOT NAME = Bottom Solder Mask	GENERATED : 3/23/2016 4:59:16 PM	TEXAS INSTRUMENTS	



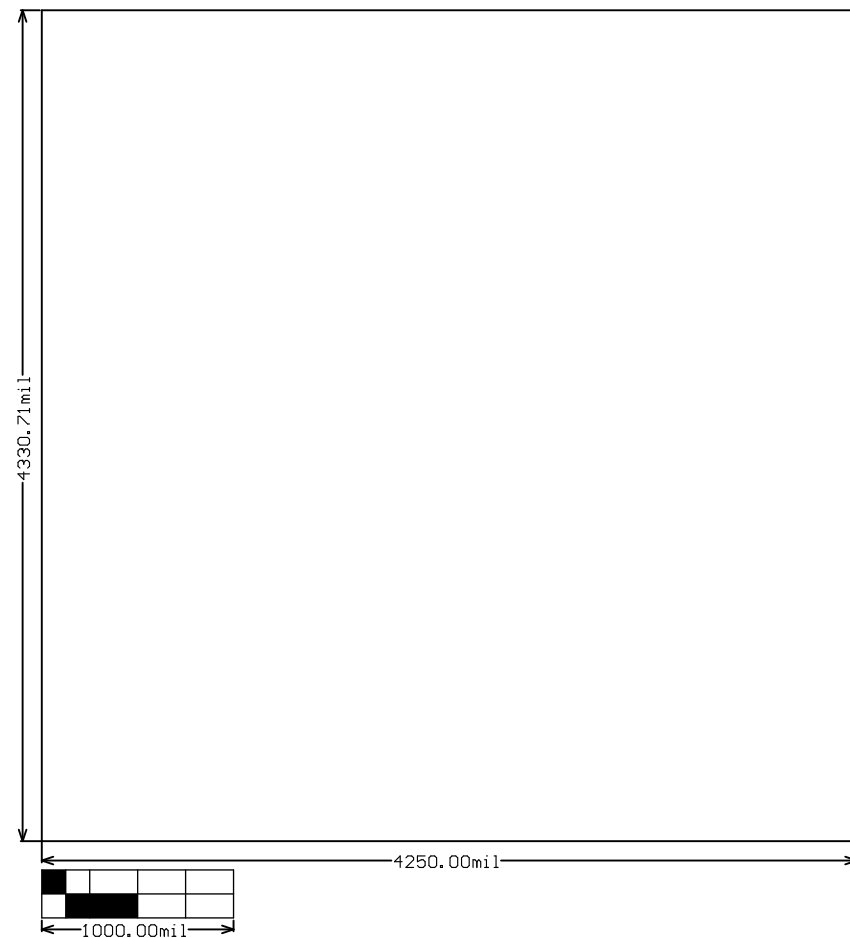
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00794	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00794		
PLOT NAME = Bottom Overlay	GENERATED : 3/23/2016 4:59:21 PM	TEXAS INSTRUMENTS	

Symbol	Hit Count	Finished Hole Size	Plated	Hole Type	Physical Length	Rout Path Length
▽	2	40.16mil (1.020mm)	PTH	Round	-	-
★	3	31.50mil (0.800mm)	PTH	Slot	118.11mil (3.000mm)	86.61mil (2.200mm)
⊕	5	7.87mil (0.200mm)	PTH	Round	-	-
▽	6	51.18mil (1.300mm)	PTH	Round	-	-
□	21	63.00mil (1.600mm)	PTH	Round	-	-
⊞	76	40.00mil (1.016mm)	PTH	Round	-	-
✕	332	20.00mil (0.508mm)	PTH	Round	-	-
	445 Total					

Slot definitions : Rout Path Length = Calculated from tool start centre position to tool end centre position.
Physical Length = Rout Path Length + Tool Size = Slot length as defined in the PCB layout



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00794	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00794		
PLOT NAME = Drill Drawing	GENERATED : 3/23/2016 4:59:26 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00794	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-00794		
PLOT NAME = Board Dimensions	GENERATED : 3/23/2016 4:59:32 PM	TEXAS INSTRUMENTS	

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